

PHOTOCOUPLER PS8103

HIGH-SPEED (200 kbps) ANALOG OUTPUT TYPE 5-PIN SOP PHOTOCOUPLER

-NEPOC Series-

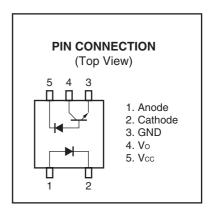
DESCRIPTION

The PS8103 is an optically coupled isolator containing a GaAs LED on the light emitting diode (input side) and a PIN photodiode and a high-speed amplifier transistor on the output side on one chip.

This is a plastic SOP (Small Out-line Package) type for high density applications.

FEATURES

- Wide operating Vcc range (Vcc = -0.5 to +15 V)
- Small package (5-pin SOP)
 - High isolation voltage (BV = 2 500 Vr.m.s.)
 - High-speed response (tphL, tpLH = 5 μ s MAX. (@RL = 4.1 k Ω))
 - Ordering number of taping product: PS8103-F3, F4: 2 500 pcs/reel
- ★ Pb-Free product
- Safety standards
 - UL approved: File No. E72422

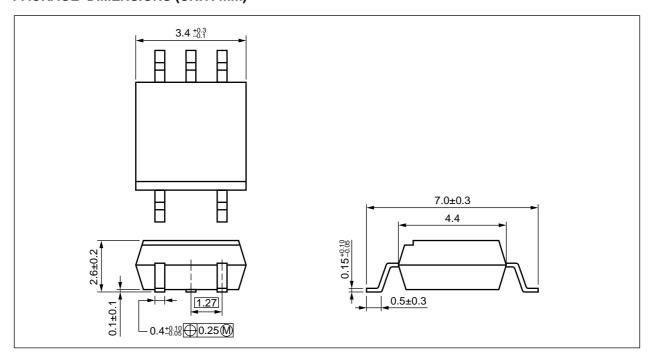


APPLICATIONS

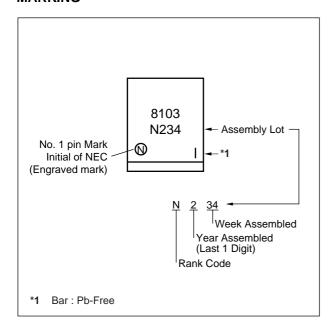
- · Computer and peripheral manufactures
- · General purpose inverter
- Substitutions for relays and pulse transformers
- · Power supply

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version. Not all devices/types available in every country. Please check with local NEC Compound Semiconductor Devices representative for availability and additional information.

PACKAGE DIMENSIONS (UNIT: mm)



★ MARKING



★ ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number ^{*1}
PS8103	PS8103-A	Pb-Free*2	Magazine case 100 pcs	Standard products	PS8103
PS8103-F3	PS8103-F3-A		Embossed Tape 2 500 pcs/reel	(UL approved)	
PS8103-F4	PS8103-F4-A				

^{*1} For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

	Parameter	Symbol	Ratings	Unit
Diode	Forward Current	lF	50	mA
	Reverse Voltage	VR	5	V
	Power Dissipation *1	Po	50	mW
Detector	Supply Voltage	Vcc	−0.5 to +15	٧
	Output Voltage	Vo	−0.5 to +15	V
	Output Current	lo	8	mA
	Power Dissipation *2	Pc	80	mW
Isolation Voltage *3		BV	2 500	Vr.m.s.
Operating Ambient Temperature		TA	-40 to +100	°C
Storage Temperature		Tstg	-55 to +125	°C

^{*1} Reduced to 0.5 mW/ $^{\circ}$ C at T_A = 25 $^{\circ}$ C or more.

^{*2} With regards to terminal solder (the solder contains lead) plated products (conventionally plated), contact your nearby sales office.

^{*2} Applies to output pin Vo. Reduced to 0.8 mW/ $^{\circ}$ C at T_A = 25 $^{\circ}$ C or more.

^{*3} AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output. Pins 1-2 shorted together, 3-4 shorted together.

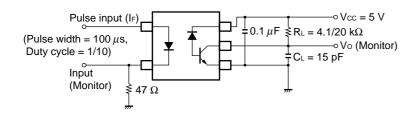
ELECTRICAL CHARACTERISTICS (TA = 25°C)

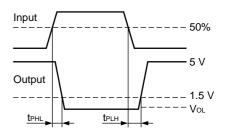
Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 16 mA		1.2	1.5	V
	Reverse Current	lR	V _R = 3 V			10	μА
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz		30		pF
Detector	High Level Output Current	Іон (1)	$I_F = 0 \text{ mA}, V_{CC} = V_0 = 5.5 \text{ V}$		7	500	nA
	High Level Output Current	Іон (2)	IF = 0 mA, Vcc = Vo = 15 V			100	μА
	Low Level Output Voltage	Vol	IF = 16 mA, Vcc = 4.5 V, IoL = 1.1 mA		0.1	0.4	٧
	High Level Supply Current	Іссн	IF = 0 mA, Vo = open, Vcc = 15 V		0.01	1	μА
	Low Level Supply Current	Iccl	IF = 16 mA, Vo = open, Vcc = 15 V		150	800	
Coupled	Current Transfer Ratio (Ic/I _F)	CTR	IF = 16 mA, Vcc = 4.5 V, Vo = 0.4 V	10	23	30	%
	Isolation Resistance	R _{I-O}	V _{I-O} = 1 kV _{DC} , RH = 40 to 60%	10 ¹¹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1 MHz		0.4		pF
	Propagation Delay Time $(H \rightarrow L)^{*2}$	tрнL	IF = 16 mA, Vcc = 5 V, RL = 4.1 k Ω , CL = 15 pF		1	5	μs
	Propagation Delay Time $(L \rightarrow H)^{*2}$	tрLН			2	5	
	Propagation Delay Time $(H \rightarrow L)^{*2}$	tрнL	$I_F = 16 \text{ mA}, \text{ Vcc} = 5 \text{ V}, \text{ RL} = 20 \text{ k}\Omega,$ $\text{CL} = 15 \text{ pF}$		1	15	
	Propagation Delay Time $(L \rightarrow H)^{*2}$	tрцн			7	15	

*1 CTR rank

L: 15 to 30 (%) N: 10 to 30 (%)

*2 Test circuit for propagation delay time



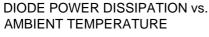


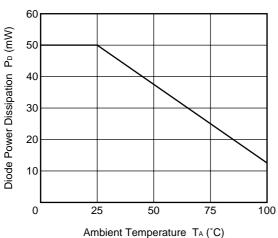
 $\ensuremath{\text{CL}}$ includes probe and stray wiring capacitance.

USAGE CAUTIONS

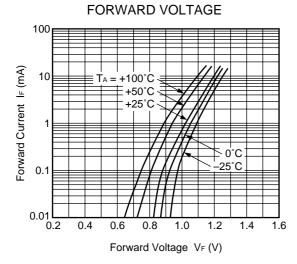
- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of 0.1 μ F is used between Vcc and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Avoid storage at a high temperature and high humidity.

TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)

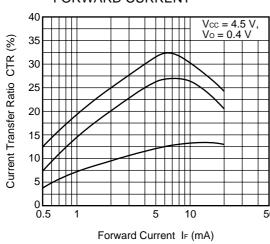




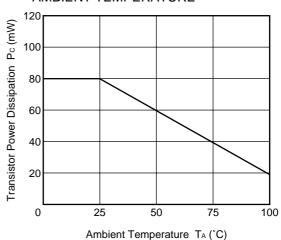
FORWARD CURRENT vs.



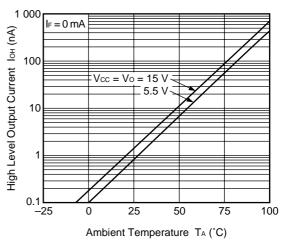
CURRENT TRANSFER RATIO vs. FORWARD CURRENT



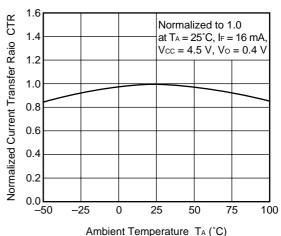
TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



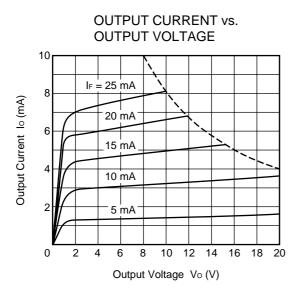
HIGH LEVEL OUTPUT CURRENT vs. AMBIENT TEMPERATURE



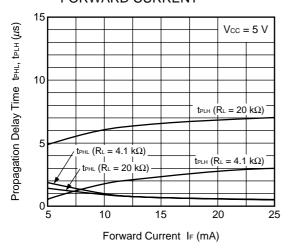
NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



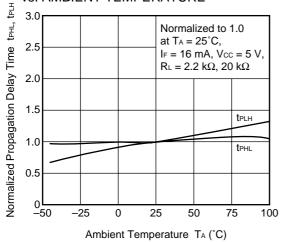
Remark The graphs indicate nominal characteristics.



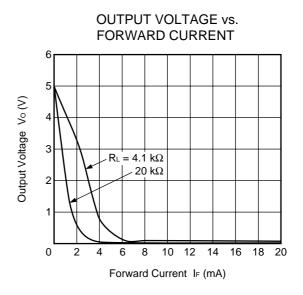
PROPAGATION DELAY TIME vs. FORWARD CURRENT



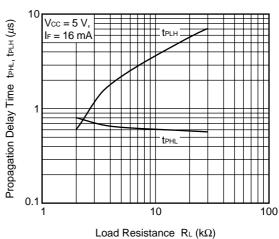
NORMALIZED PROPAGATION DELAY TIME vs. AMBIENT TEMPERATURE



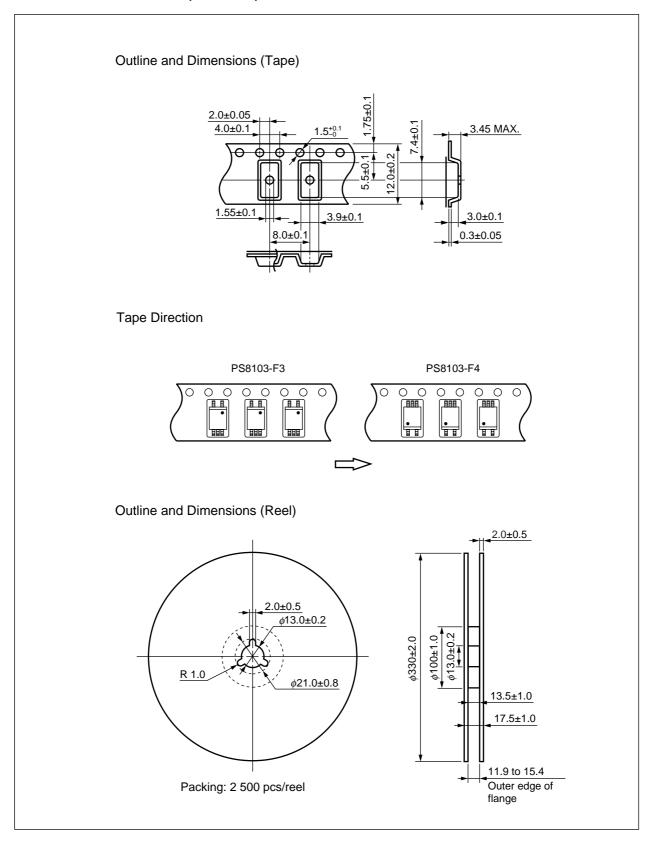
Remark The graphs indicate nominal characteristics.



PROPAGATION DELAY TIME vs. LOAD RESISTANCE



TAPING SPECIFICATIONS (UNIT: mm)



NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

· Peak reflow temperature 260°C or below (package surface temperature)

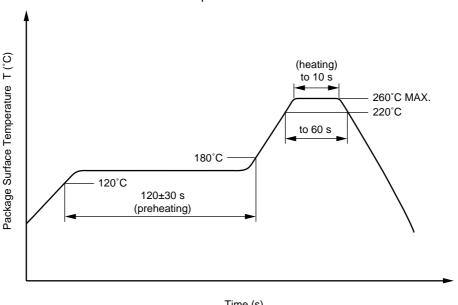
• Time of peak reflow temperature 10 seconds or less • Time of temperature higher than 220°C 60 seconds or less

• Time to preheat temperature from 120 to 180°C 120±30 s · Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

· Preheating conditions 120°C or below (package surface temperature)

• Number of times One (Allowed to be dipped in solder including plastic mold portion.)

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

• Peak Temperature (lead part temperature) 350°C or below 3 seconds or less • Time (each pins)

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(b) Please be sure that the temperature of the package would not be heated over 100°C

(4) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

★ USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.



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Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The -AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)		on contained devices	
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)	
Mercury	< 1000 PPM	Not Detected		
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	< 1000 PPM	Not Detected		
PBB	SB < 1000 PPM		Not Detected	
PBDE	< 1000 PPM Not Detected		etected	

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

Important Information and Disclaimer: Information provided by CEL on its website or in other communications concerting the substance content of its products represents knowledge and belief as of the date that it is provided. CEL bases its knowledge and belief on information provided by third parties and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. CEL has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. CEL and CEL suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall CEL's liability arising out of such information exceed the total purchase price of the CEL part(s) at issue sold by CEL to customer on an annual basis.

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